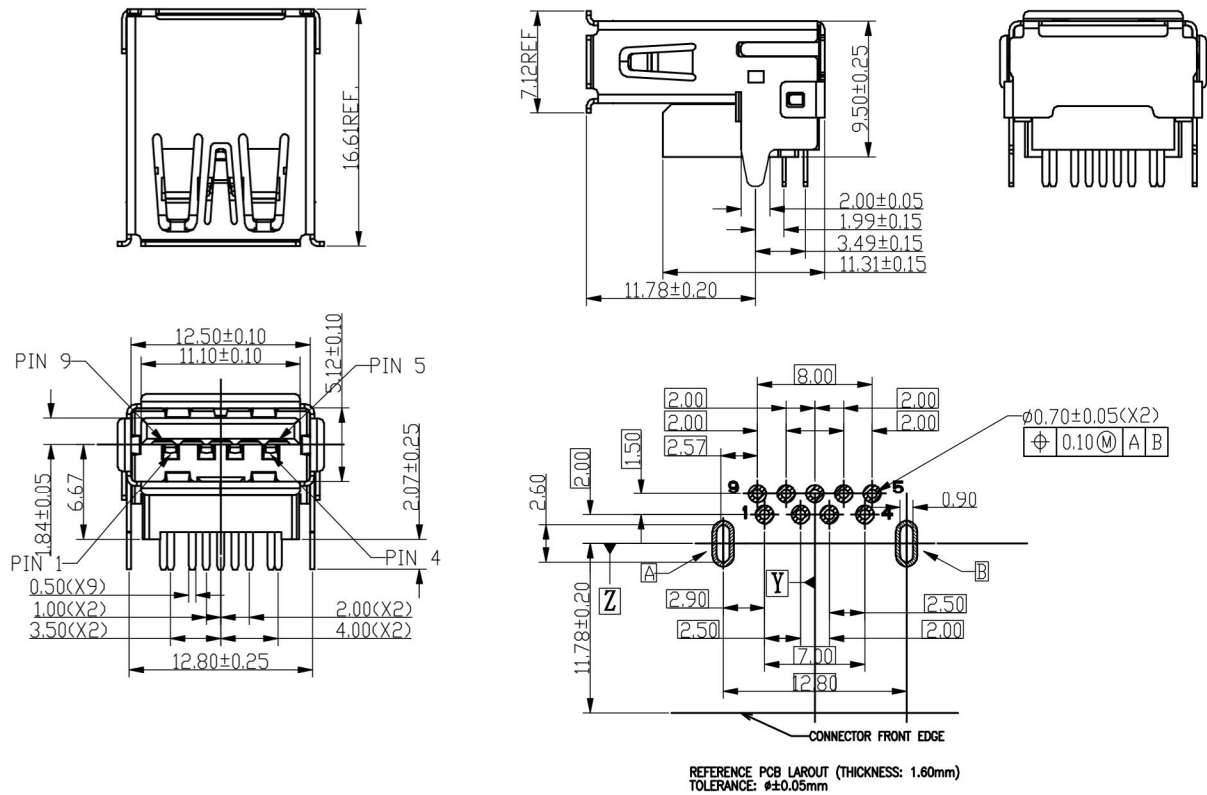


USB3.0 AF 90度插板 成品图(垫高9.5)



Material
Housing Material: LCP, UL94V-0, blue
Contact Terminal: Copper Alloy
Metallic Shell: SUS
Plating
Underplating: Nickel
Contact Plating: 1μ" Gold
Solder Tail: 100μ" Min. Tin
Metallic Shell: Nickel
Electrical
Voltage Rating: 100 V AC
Current Rating: 0.25A (Signal pins 2,3,5,6,7,8,9) 1.8A (Power Pins 1,4)
Contact Resistance: 30mΩ Max.
Insulation resistance: 1000MΩ Min.
Dielectric withstanding voltage: 100V AC/Minute
Mechanical
Durability: 1500 cycles
Mating Force: 35N (3.57Kgf) Max
Unmating Force: 10N (1.02Kgf) Min. initial, 8N min after test
Environmental and Processing
Operating Temperature: -40°C to +85°C

Pin #	SIGNAL NAME	DESCRIPTION	
1	VBUS	POWER	
2	D-	USB 2.0 DIFFERENTIAL PAIR	
3	D+		
4	GND	GROUND FOR POWER RETURN	
5	StdA_SSRX-	SUPER SPEED RECEIVER DIFFERENTIAL PAIR	
6	StdA_SSRX+		
7	GND_DRAIN	GROUND FOR SIGNAL RETURN	
8	StdA_SSTX-	SUPER SPEED TRANSMITTER DIFFERENTIAL PAIR	
9	StdA_SSTX+		
Shell	Shield	CONNECTOR METAL SHELL	

							DSND		SCALE: N/A	MODEL TYPE: USB 3.0				
				ANGLAR	±5°		DWN		VIEW: 	PART NO.: XB-USB-A11-F11211				
				L≤ 4	±0.2		CHKD		UNIT: mm/in	DWG NO.: USB3.0 AF 90度插板				
				4<L≤ 16	±0.3		APPD		SIZE: A4					
				16<L≤ 63	±0.4									
		DATE	REVISED	APPROVED	L> 63	±0.5								
REVISIONS						UNSPECIFIED TOLERANCES		DONG GUAN XI BANG ELECTRONIC CO., LTD				WEIGHT	SHEET	REVISION
www.alpsr.com www.gdxjdz.com www.xbswitch.com													1/1	A0